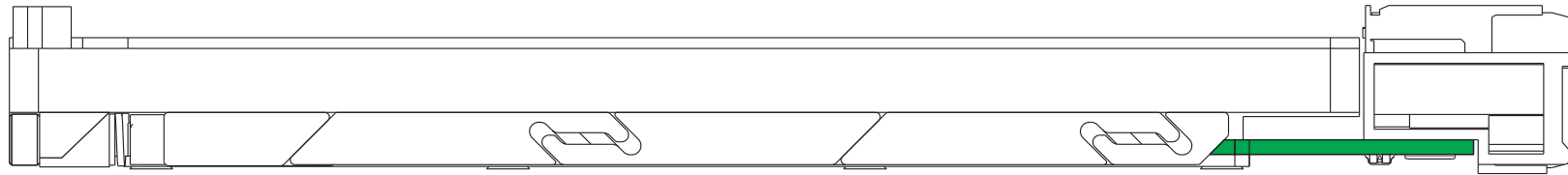
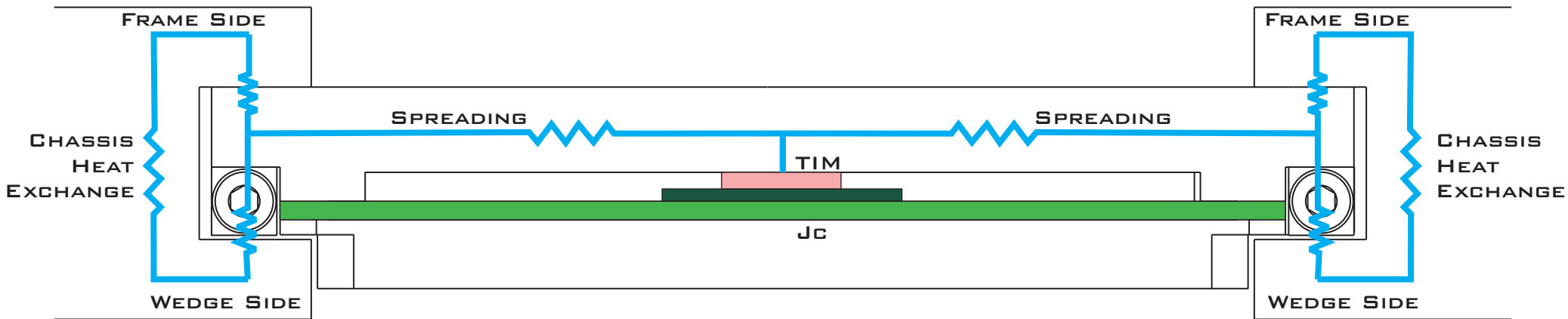


SECONDARY SIDE WEDGE LOCKS



PCB REMOVED FROM COLDWALL THERMAL PATH
CONVECTION FRONT PANEL HOLES REMOVED FROM PCB



$$\theta_{(COLDWALL)} = \frac{(\theta_{(WEDGE SIDE)} \times \theta_{(FRAME SIDE)})}{\theta_{(WEDGE SIDE)} + \theta_{(FRAME SIDE)}}$$

$$\theta_{(COLDWALL)} = \frac{(.42C^{\circ}/W \times .11C^{\circ}/W)}{(.42C^{\circ}/W + .11C^{\circ}/W)}$$

$$\theta_{(COLDWALL)} = \sim 0.09 C^{\circ}/W \text{ PER EDGE}$$

$$\theta_{(COLDWALL)} = \sim 0.05 C^{\circ}/W$$

THERMAL RESISTANCE VLAUES:

WEDGE SIDE = 0.42C°/W

FRAME SIDE = 0.11C°/W

2 EDGES PER CARD